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Impact of Technology Trends on Computer Architecture



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Diversity of Disciplines at IBM Research



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IBM Research's Strategic Thrusts



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Conversation at a party

- So, what do you do professionally?
- I am a Computer Architect
- (pause silence....)
- Oh, I see... so you design computer cases.

How come most of the time they are so boring, even ugly?

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Architecture vs Chip Architecture





Information Art - Diagramming Microchips September 6 - October 30, 1990 The Museum of Modern Art, New York

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Impact of Technology Trends on Architecture

- Science, engineering and technology are constantly providing new materials, tools, methods, etc., leading to changes in the architecture of buildings
 - Constant evolution of capabilities, enabling all sorts of innovation
- Similarities can also be drawn with other areas
 - Cars, for example



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Knowing the Technologies and their Limitations



On November 7, 1940, at approximately 11:00 AM, the first Tacoma Narrows suspension bridge collapsed due to wind-induced vibrations. Situated on the Tacoma Narrows in Puget Sound, near the city of Tacoma, Washington, the bridge had only been open for traffic a few months.

"Disasters" may also happen in Computer Architecture, albeit no so dramatically, as a consequence of the use of the technologies



Impact of Technology Trends on Computer Architecture

- What is Computer Architecture?
 - (Valentina already gave us a good perspective)
- In one simple term: a "contract"
 - Conceptually, very similar to the architecture of a building
 - A specification for the "builder" \rightarrow computer engineers
 - A specification for the "user" \rightarrow software engineers
- But there are some important differences
 - Technology evolves very fast, so a system looses its advantages in a short period
 - ... imagine if that was also the case for homes
 - Although systems change rapidly, expectation is that software migrates from system to system "transparently"
 - Compatibility with "performance" scalability
- Because of the technology changes, a successful "computer architecture" normally has many different "implementations"



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Levels of Computer Architecture

- Multiple levels in Computer Architecture
 - Multiple "contracts" throughout a system
 - System, Network, Multiprocessor, Processor, Cache memory, Pipeline, ...
- In some cases, we use the term "microarchitecture" to refer to lower levels
 - Microarchitecture closely related to "organization"
 - One "processor architecture" may have multiple "microarchitectures"
 - Each "microarchitecture" may have multiple implementations
- Technology trends impact primarily the implementations, but the effects are often visible at the architecture levels

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Technology Trends Example

- A simplistic view
 - Early 70s: Memory was small and slow, compiler technology not mature
 - Complex instruction sets (CISC), "semantic gap," language-specific machines
 - Early 80s: Memory improving rapidly, advances in compiler technology
 - RISC (Reduced Instruction Set) processors emerge
 - Semantic gap replaced by sequences of instructions
 - RISC vs CISC debated extensively
 - Early 90s: Transistor density enables more logic in a chip
 - CISC translated into RISC on-the-fly
 - RISC vs CISC debate became pointless all RISC internally
 - Early 00s: Transistor density enables even more logic in a chip
 - Processors becoming more CISCy again ..?
- Key observation
 - Changes in technology can trigger major transitions in Computer Architecture
 - Recognizing and anticipating the changes leads to breakthroughs



Examples of Technologies in Computing

- Logic and Main Memory
 - -Vacuum tubes
 - Magnetic core memory
 - -Semiconductor transistors and memory
 - Integrated circuits: SSI (small), MSI (medium),
 LSI (large), VLSI (very large)
 - -Bipolar, NMOS/PMOS, CMOS
 - -Many others
 - Gallium Arsenide, Bubble memories, etc.

- Storage
 - -Magnetic drums, disks, tapes
- Input/output devices
 - -Keypads, switches, teletype writers
 - -Punched cards, punched tape
 - -Dot-matrix printers
 - -32x80 characters display
 - -Graphics displays, High-resolution devices
 - -etc., etc.

Every major technology innovation has brought major changes to the architecture of computers ... and it continues to be so

Technology eras

c core memory era	
volatile	
er capacity, more reliable	

- - Much larger capacity (logic and memory)

Examples of Technology Eras in Computing

- Vacuum tube era
 - Very little logic, very little memory
 - Very short time to failure

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- Magnetic
 - Non-
 - Large
- Semiconductor era













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Technologies define Eras

- Not one but multiple technologies define an era
 - Processor and memory
 - Storage
 - Communications
 - I/O devices
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- Consequently, eras have different attributes
- Eras can also be recognized by the usage mode of the computers
 - Batch
 - Interactive
 - Web-driven
 - Real-time driven

Primary focus today

(Chip architecture)

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Recent Microelectronics Technology Eras

- **Bipolar Transistors Era**
 - -Dominated industry in the early years of modern computers
 - -Provided continued improvement in the characteristics of the systems
 - Increased number of transistors in a • chip and their speed
 - -However, bipolar transistors consume power constantly
- **CMOS** Transistors Fra
 - -Consume power only when there is switching activity
 - -Initially, slower than bipolar transistors but eventually became faster
 - -Continued trend of improving performance at each generation, without requiring changes to the software
 - Historic trend: 2x every 2 years at • roughly constant cost

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Easy migration for software

Widespread adoption of computing technology



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Major Trends: Transistor Density and Frequency



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Where did we go "wrong"?
 Explosion of leakage current



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CMOS Era: Benefits from Technology Scaling are Diminishing



No more "free ride" for software ...

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Didn't we have this problem in the past...?

- Bipolar Era symptoms are back ...
- ... but there is no other semiconductor technology ready to be used this time
- ... at least not for a number of years
 - Nanotubes
 - Quantum computing
 - Molecular computing
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A New "Technology" Era - The "CMOS Transition" Era



- CMOS scaling alone can no longer provide simultaneous improvements in all product metrics (performance, cost, power, software compatibility) at the historic rate.
- New technologies, systems and software evolution will be required to achieve performance and cost improvements over the next decade.
- Computer architectures will have to drive the transition

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Where are we today?

- CMOS density continues roughly at historic rate while operating frequency is basically flat, because of power limitations
 - -We can have more transistors per chip but cannot have them run faster
 - If they run faster, we cannot use all of them at the same time
- Single-thread performance improving slowly
- Transitioning to multicores, accelerators, specialized systems
 - -Software changes required
 - Leverage point is moving "up the system stack"

- Technologies other than CMOS needed to compensate the trends
 - -Semiconductor materials and structures, lithography, design layout
 - Operation at ultra-low voltage, advanced power management
 - -Cooling
 - -3D integration
 - -New memory technologies, denser and lower power, non-volatile
 - -On-chip optical communications (photonics)
 - -Heterogeneous and specialized engines and systems

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Why 3D Integration?

- Multi-core, multi-threaded and multi-image (virtualization) chips are stressing memory bandwidth and on-chip memory capacity
- Advances in technology providing much higher I/O densities and bandwidth between chips
- Mix different types of chips in one package
- Design challenges: thermal, package I/O, etc.
- Impact to architecture (example)
 - No longer constrained by 2D organization
 - What if we had Gigabytes of cache memory on chip, and could transfer several Kilobytes per cycle across cache levels?



Solder bumped chip stacked 3D



Wire bonded chip stacked 3D

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3D Integration

Restructuring the architecture of the chip / node



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New Memory Technologies

- Phase-change Memory (PCM) attributes:
 - Fast: Tens of nano-seconds
 - Low-Power: Non-volatile storage
 - Dense: Multi-bit, projected to be comparable to disks

- Impact to architecture (example)
 - What if we had Terabytes of main memory, but the number of write operations are limited?

	DRAM	РСМ	NAND FLASH	enterprise Disk
Read access time (us)	0.05	0.1	20	5000
Random Write Access (us)	0.05	0.1	1500	5000
Device Capacity (GB)	0.5	140	32	500 - 2500
Device Bandwidth (MB/s)	1000	1000	20	150
Endurance	1015	109 - 1012	105	1012
Device Power (W)	0.2	0.1	0.1 - 0.2	10-20

Legend: Best Barrier

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Optical Interconnect Technology

- Impact to architecture (example)
 - What if we could transfer data within a system 100 times faster?

2008	2010	2014	2018
5G Active Cable	10G Optics on chip	10G–20G Optics on card	10G–20G+ Optics w/3D Integrated Photonics
		Possible technologies: Fiber, waveguide flex or WG on card	
5G optics at rack edge	10G Optics mid-card		

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Heterogeneous Systems

- Emergence of heterogeneous components in processor and systems
 - Recently announced "Roadrunner" supercomputer has Cell and x86 chips
 - Fastest and most power efficient computer in the world
- Impact to architecture (example)
 - What is the architecture of a system with increased heterogeneity (hardware and software)?



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Reconfigurable Logic

- Reconfigurable logic offers substantial performance, versatility and power consumption
 - -At the cost of software complexity
- FPGAs are being deployed in general-purpose systems and appliances
- The multi-core transition opens a window of opportunity for reconfigurable logic
 - -Multicore also requires software modifications/rewrite
- Impact to architecture
 - -What is the most effective architecture of a system with reconfigurable logic?



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Increasing Reliance on System and Software for Performance

Leverage point is moving up the stack

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- Driving performance and cost requirements back to technology and chips
- Significant interdependence of technology with chips, systems and software



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The CMOS Transition Era

- Power continues to be the principal concern facing computer architectures today
- Not discussed today but also gaining relevance: Reliability
 - Design, manufacturing and operational challenges to overcome defects and failures
- Entering the "CMOS Transition" Era in Computer Architecture
 - Technologies other than CMOS will be deployed to continue historic performance growth trends
 - 3D silicon integration, phase-change memory, optics on chip, reconfigurable logic
 - Packaging technology will grow in importance, as chips increase in complexity
 - Systems based on chips with multiple processors (cores) are becoming widespread.
 - Generally, they are characterized by improving throughput performance and power-performance, but not single-thread performance
 - Innovation needed to improve single-thread performance
 - Programming languages, compilers, tools, etc.
- Parallelism levels that once were only within the high performance computing (HPC) domain are becoming more common, and will need to be exploited at all levels of the software stack

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Where are we going?

- In about 10 years, there will be about 50B transistors in a single chip
 - What do we do with these many transistors? What are the best ways to exploit them?
 - How do we design chips of this complexity?
- Entering eras beyond Giga
 - Teraflops, Terabytes, etc.... "Era of Tera" (Intel)
- Exascale systems in 10-20 years
 - 1000x what we have today
 - Roadrunner: I Petaflop today -- I Exaflop in late '10s
- Data being generated at increasing rates and at increasing speeds
 - Human generated, machine generated
 - No longer possible to store all the data processing on the fly (stream processing)
- These are just some examples
 - All of them will lead to advances in Computer Architecture

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Understand the Technology Trends ...



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